

**General Description**

The SJM40ND100 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

**Features**

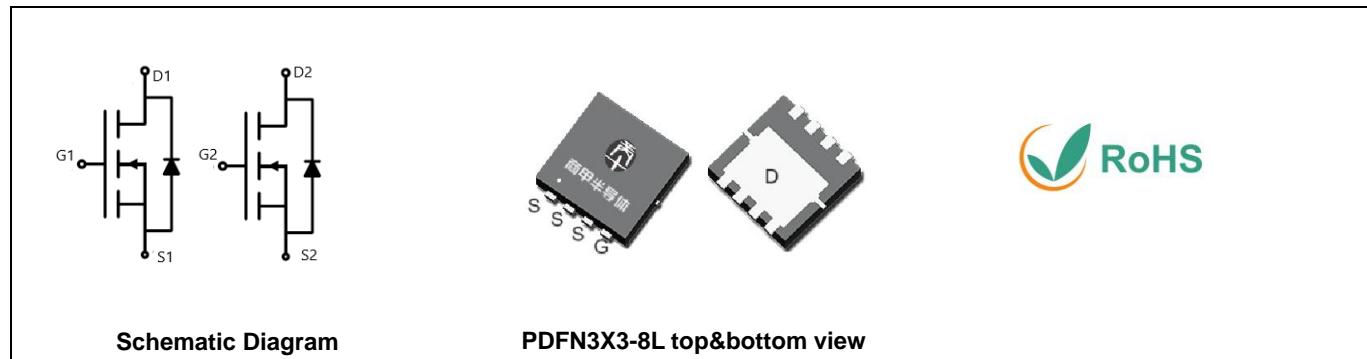
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

**Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

**Key Performance Parametes**

Parameter	Value	Unit
$V_{DS}$	40	V
$R_{DS(ON)}_{TYP}$	13.8	mΩ
$I_D$	26	A
$Q_G$	24.5	nC

**Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM40ND100	SJM40ND100	PDFN3X3-8L	Tape	\	\	5000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	40	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_c=25^\circ\text{C}$ )	26	A
	Drain Current-Continuous( $T_c=100^\circ\text{C}$ )	17	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	104	A
$P_D$	Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )	24	W
	Maximum Power Dissipation( $T_c=100^\circ\text{C}$ )	9.4	W
$E_{AS}$	Avalanche energy (Note 2)	90	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{θJC}$	Thermal Resistance, Junction-to-Case		5.3	°C/W



## 40V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	40			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=40\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	$\mu\text{A}$
		$V_{\text{DS}}=40\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	1		2.5	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_{\text{D}}=20\text{A}$		34		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$		13.8	17.9	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=15\text{A}$ $T_J=25^\circ\text{C}$		15.7	21	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=20\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		1314		pF
$C_{\text{oss}}$	Output Capacitance			95.4		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			78.5		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		1.8		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=20\text{V}$ , $R_L=1\Omega$ , $R_{\text{GEN}}=6\Omega$		12.6		nS
$t_r$	Turn-on Rise Time			3.6		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			30.8		nS
$t_f$	Turn-Off Fall Time			3.2		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=20\text{V}$ , $I_{\text{D}}=20\text{A}$		24.5		nC
$Q_{\text{gs}}$	Gate-Source Charge			3.7		nC
$Q_{\text{gd}}$	Gate-Drain Charge			6.2		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				26	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=20\text{A}$			1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		17.5		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		10.9		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=40\text{V}$ ,  $V_G=10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



## Typical Electrical And Thermal Characteristics (Curves)

Figure 1. Output Characteristics

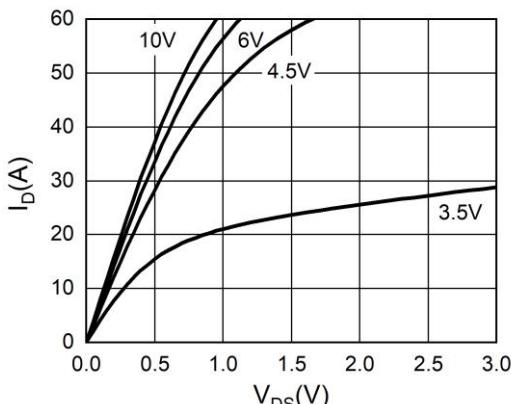


Figure 2. Transfer Characteristics

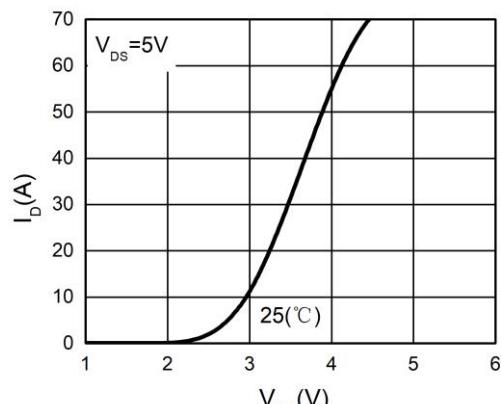


Figure 3. Power Dissipation

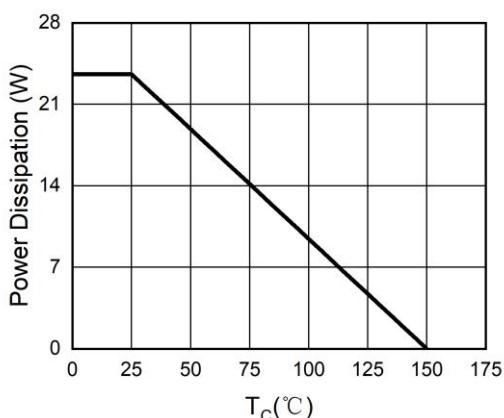
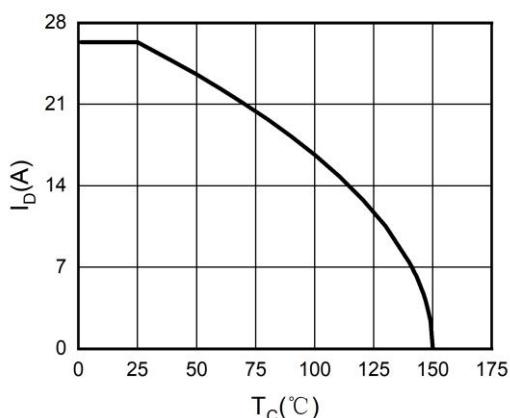
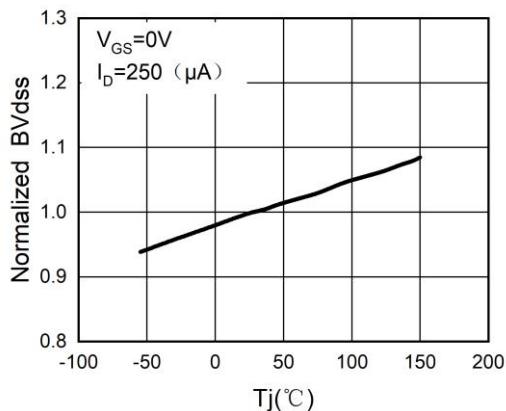
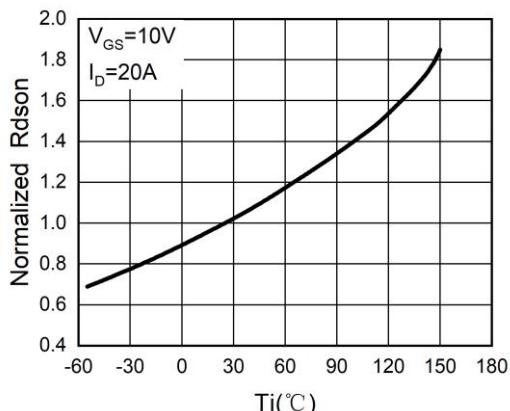
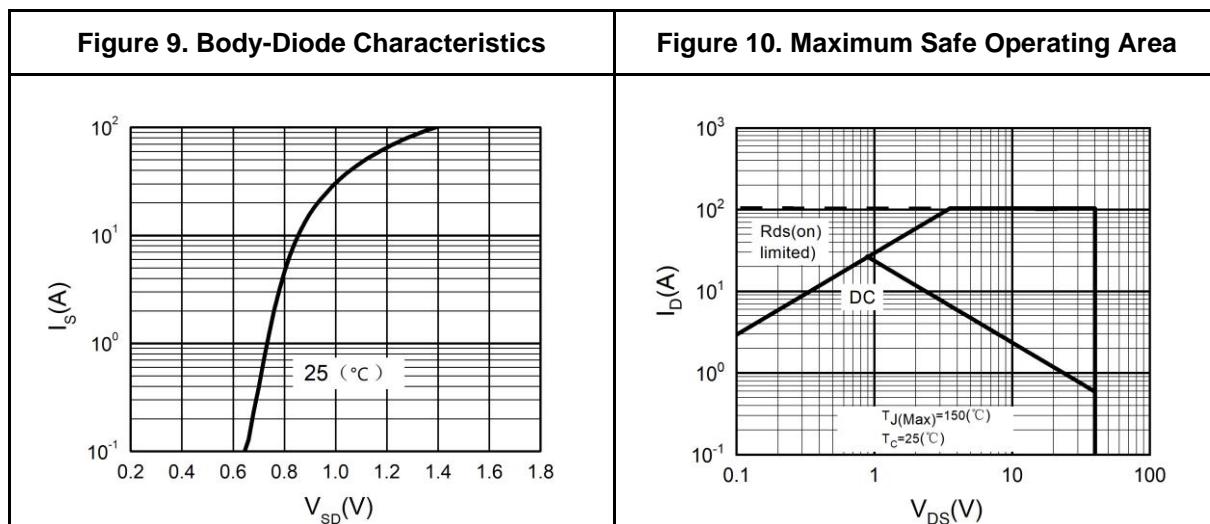
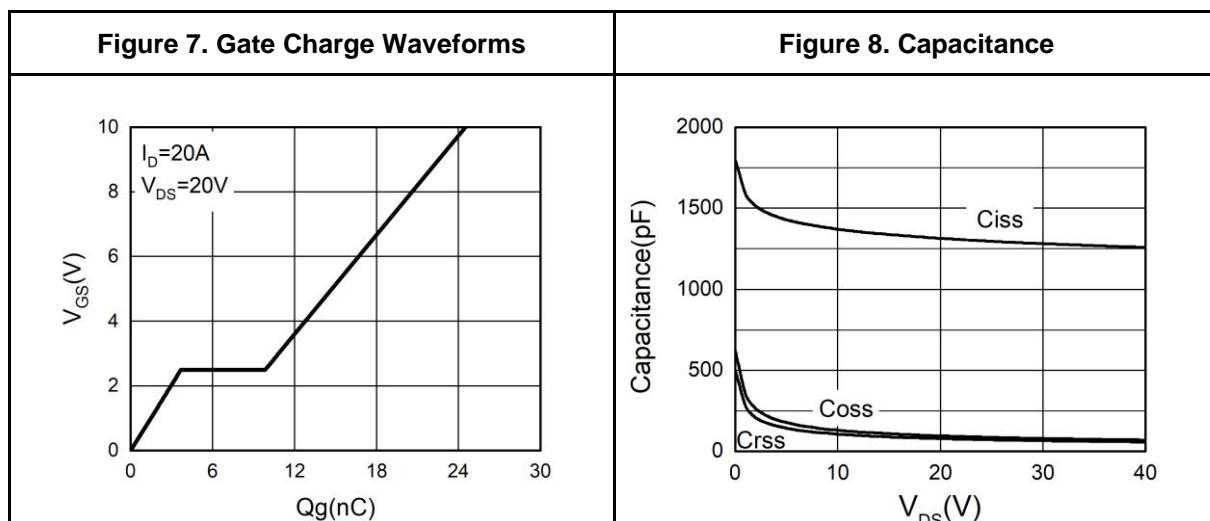


Figure 4. Drain Current

Figure 5.  $\text{BV}_{\text{DSS}}$  vs Junction TemperatureFigure 6.  $R_{\text{DS(ON)}}$  vs Junction Temperature

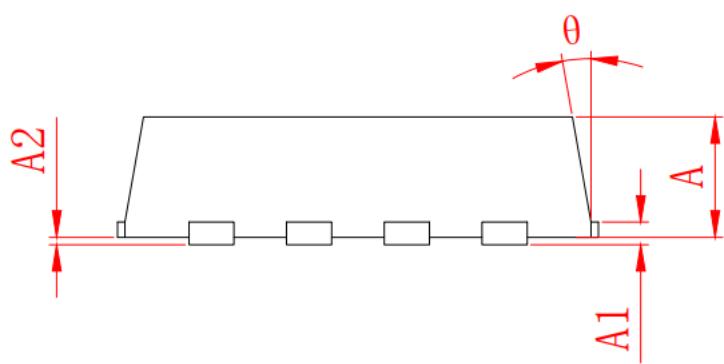
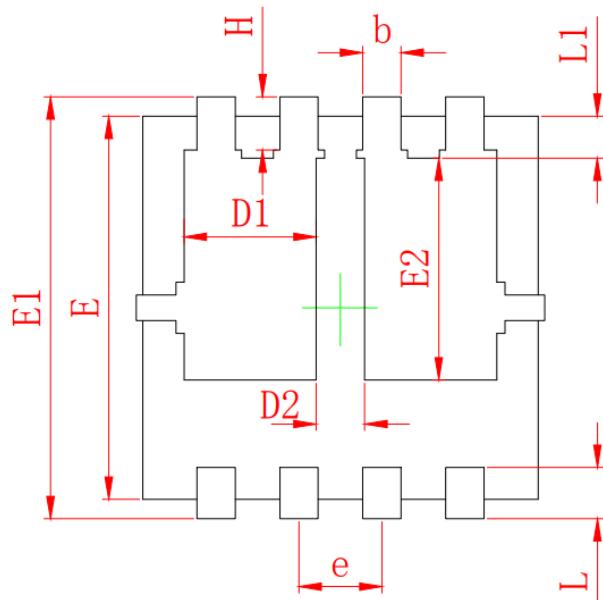
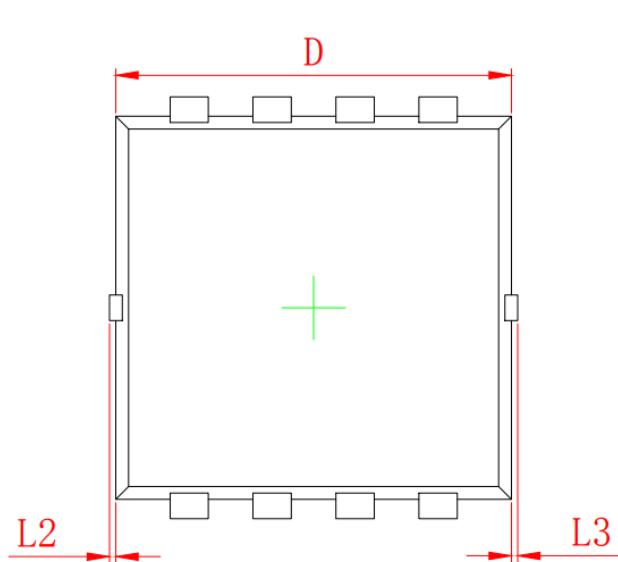


## Typical Electrical And Thermal Characteristics (Curves)





PDFN3X3-8L Package Information



SYMBOL	MILLIMETER	
	MIN	MAX
A	0.700	0.900
A1	0.152	REF.
A2	0~0.05	
D	3.000	3.200
D1	0.935	1.135
D2	0.280	0.480
E	2.900	3.100
E1	3.150	3.450
E2	1.535	1.935
b	0.200	0.400
e	0.550	0.750
L	0.300	0.500
L1	0.180	0.480
L2	0~0.100	
L3	0~0.100	
H	0.315	0.515
$\theta$	8°	12°



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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